



# JCS50N20T

## 主要参数 MAIN CHARACTERISTICS

$I_D$	50A
$V_{DSS}$	200 V
$R_{dson-max}$ (@ $V_{gs}=10V$ )	50m $\Omega$
$Q_g-typ$	90nC

### 用途

- 高频开关电源
- 电子镇流器
- UPS 电源

### 产品特性

- 低栅极电荷
- 低  $C_{rss}$
- 开关速度快
- 产品全部经过雪崩测试
- 高抗  $dv/dt$  能力
- RoHS 产品

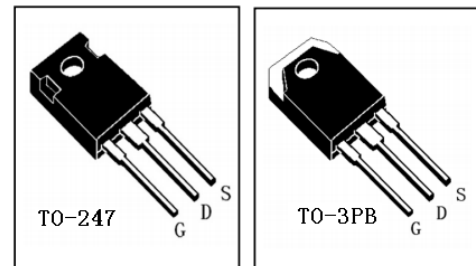
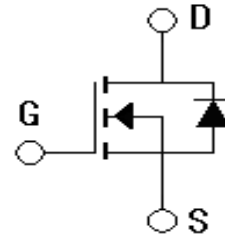
### APPLICATIONS

- High frequency switch mode power supplies
- Electronic lamp ballasts based on half bridge
- UPS

### FEATURES

- Low gate charge
- Low  $C_{rss}$
- Fast switching
- 100% avalanche tested
- Improved  $dv/dt$  capability
- RoHS product

## 封装 Package



## 订货信息 ORDER MESSAGE

订货型号 Order codes	印记 Marking	封装 Package	无卤素 Halogen Free	包装 Packaging	器件重量 Device Weight
JCS50N20WT-O-W-N-B	JCS50N20WT	TO-247	否 NO	条管 Tube	6.1g (typ)
JCS50N20ABT-O-AB-N-B	JCS50N20ABT	TO-3PB	否 NO	条管 Tube	5.14g (typ)





## 绝对最大额定值 ABSOLUTE RATINGS (Tc=25℃)

项 目 Parameter	符 号 Symbol	数 值 Value	单 位 Unit
		JCS50N20WT/ABT	
最高漏极-源极直流电压 Drain-Source Voltage	V <sub>DSS</sub>	200	V
连续漏极电流 Drain Current -continuous	I <sub>D</sub> T=25℃ T=100℃	50	A
		31	A
最大脉冲漏极电流(注 1) Drain Current – pulse (note 1)	I <sub>DM</sub>	200	A
最高栅源电压 Gate-Source Voltage	V <sub>GSS</sub>	±30	V
单脉冲雪崩能量(注 2) Single Pulsed Avalanche Energy (note 2)	E <sub>AS</sub>	1000	mJ
雪崩电流(注 1) Avalanche Current (note 1)	I <sub>AR</sub>	50	A
重复雪崩能量 (注 1) Repetitive Avalanche Energy (note 1)	E <sub>AR</sub>	27.7	mJ
二极管反向恢复最大电压变化速率(注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.4	V/ns
耗散功率 Power Dissipation	P <sub>D</sub> T <sub>C</sub> =25℃ -Derate above 25℃	277	W
		2.22	W/℃
最高结温及存储温度 Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~+150	℃
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T <sub>L</sub>	300	℃

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature





## 电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
<b>关态特性 Off –Characteristics</b>						
漏—源击穿电压 Drain-Source Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	200	-	-	V
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D=250\mu A$ , referenced to $25^\circ C$	-	0.22	-	
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=200V, V_{GS}=0V, T_C=25^\circ C$	-	-	1	$\mu A$
		$V_{DS}=160V, T_C=125^\circ C$	-	-	10	$\mu A$
正向栅极体漏电流 Gate-body leakage current, forward	$I_{GSSF}$	$V_{DS}=0V, V_{GS}=30V$	-	-	100	nA
反向栅极体漏电流 Gate-body leakage current, reverse	$I_{GSSR}$	$V_{DS}=0V, V_{GS}=-30V$	-	-	-100	nA
<b>通态特性 On-Characteristics</b>						
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D=250\mu A$	2	-	4	V
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D=25A$	-	42	50	m $\Omega$
正向跨导 Forward Transconductance	$g_{fs}$	$V_{DS} = 40V, I_D=25A$ (note 4)		27	-	S
<b>动态特性 Dynamic Characteristics</b>						
输入电容 Input capacitance	$C_{iss}$	$V_{DS}=25V,$ $V_{GS}=0V,$ $f=1.0MHz$	-	3250	4225	pF
输出电容 Output capacitance	$C_{oss}$		-	672	863	pF
反向传输电容 Reverse transfer capacitance	$C_{rss}$		-	70	91	pF





## 电特性 ELECTRICAL CHARACTERISTICS

开关特性 Switching Characteristics						
延迟时间 Turn-On delay time	$t_{d(on)}$	$V_{DD}=100V, I_D=50A, R_G=25\Omega$	-	82	112	ns
上升时间 Turn-On rise time	$t_r$	$V_{GS}=10V$	-	501	655	ns
延迟时间 Turn-Off delay time	$t_{d(off)}$	(note 4, 5)	-	237	309	ns
下降时间 Turn-Off Fall time	$t_f$		-	202	263	ns
栅极电荷总量 Total Gate Charge	$Q_g$	$V_{DS}=160V,$	-	90	110	nC
栅-源电荷 Gate-Source charge	$Q_{gs}$	$I_D=50A$	-	26	-	nC
栅-漏电荷 Gate-Drain charge	$Q_{gd}$	$V_{GS}=10V$ (note 4, 5)	-	33	-	nC
漏-源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings						
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current		$I_S$	-	-	50	A
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current		$I_{SM}$	-	-	200	A
正向压降 Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=50A$	-	-	1.5	V
反向恢复时间 Reverse recovery time	$t_{rr}$	$V_{GS}=0V, I_S=50A$	-	175	-	ns
反向恢复电荷 Reverse recovery charge	$Q_{rr}$	$di_f/dt=100A/\mu s$ (note 4)	-	1.23	-	$\mu C$

## 热特性 THERMAL CHARACTERISTIC

项 目 Parameter	符 号 Symbol	最大 Max		单 位 Unit
		JCS50N20WT/ABT		
结到管壳的热阻 Thermal Resistance, Junction to Case	$R_{th(j-c)}$	0.45		$^{\circ}C/W$
结到环境的热阻 Thermal Resistance, Junction to Ambient	$R_{th(j-A)}$	62.5		$^{\circ}C/W$

注释:

- 1: 脉冲宽度由最高结温限制
- 2:  $L=0.8mH, I_{AS}=50A, V_{DD}=50V, R_G=25\Omega$ , 起始结温  $T_J=25^{\circ}C$
- 3:  $I_{SD} \leq 50A, di/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$ , 起始结温  $T_J=25^{\circ}C$
- 4: 脉冲测试: 脉冲宽度  $\leq 300\mu s$ , 占空比  $\leq 2\%$
- 5: 基本与工作温度无关

Notes:

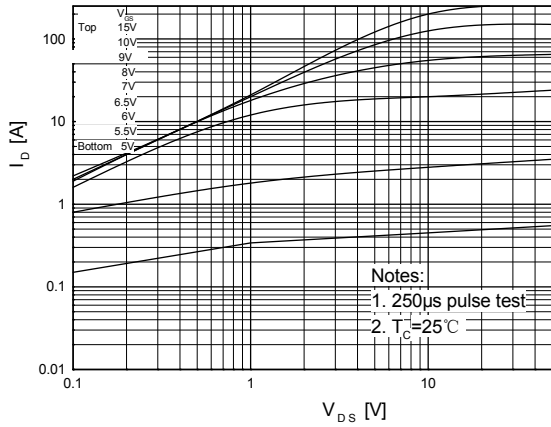
- 1: Pulse width limited by maximum junction temperature
- 2:  $L=0.8mH, I_{AS}=50A, V_{DD}=50V, R_G=25\Omega$ , Starting  $T_J=25^{\circ}C$
- 3:  $I_{SD} \leq 50A, di/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^{\circ}C$
- 4: Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycles  $\leq 2\%$
- 5: Essentially independent of operating temperature



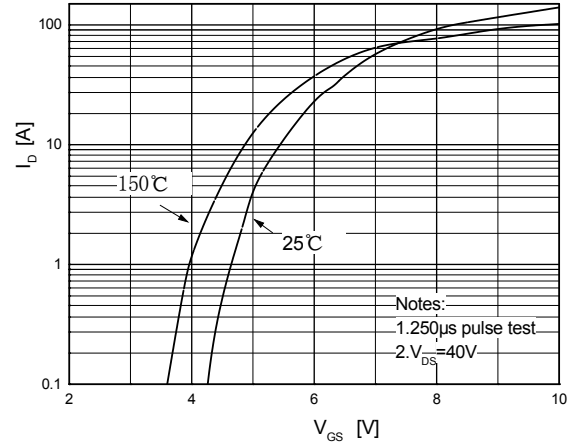


特征曲线 ELECTRICAL CHARACTERISTICS (curves)

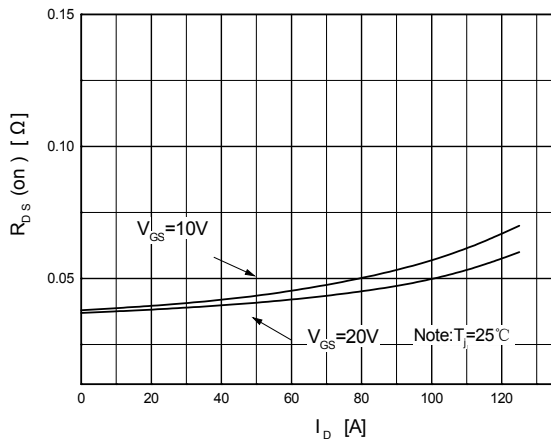
On-Region Characteristics



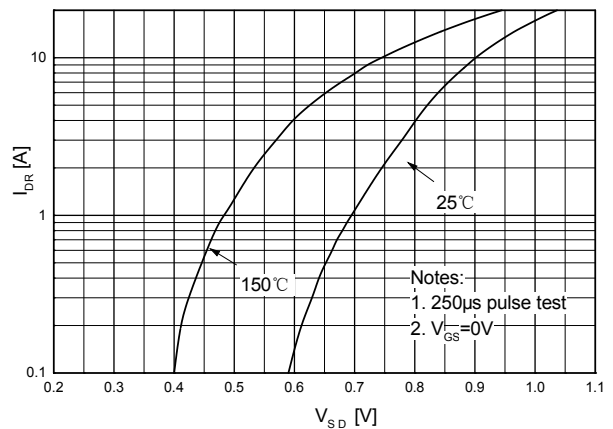
Transfer Characteristics



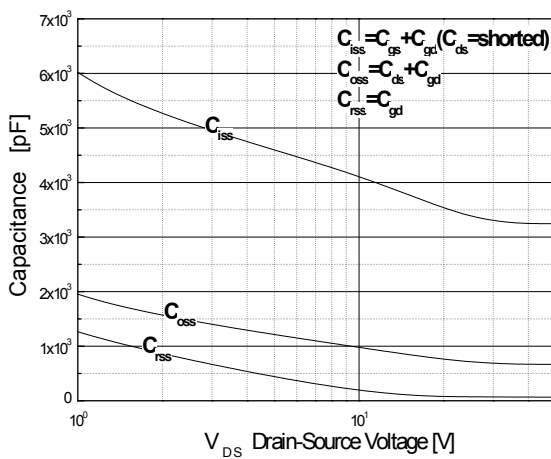
On-Resistance Variation vs. Drain Current and Gate Voltage



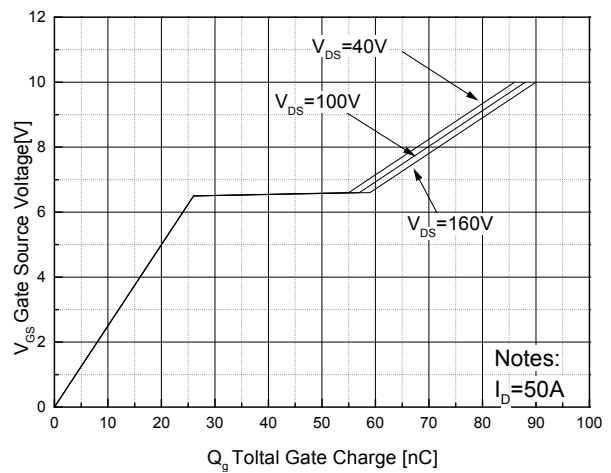
Body Diode Forward Voltage Variation vs. Source Current and Temperature



Capacitance Characteristics



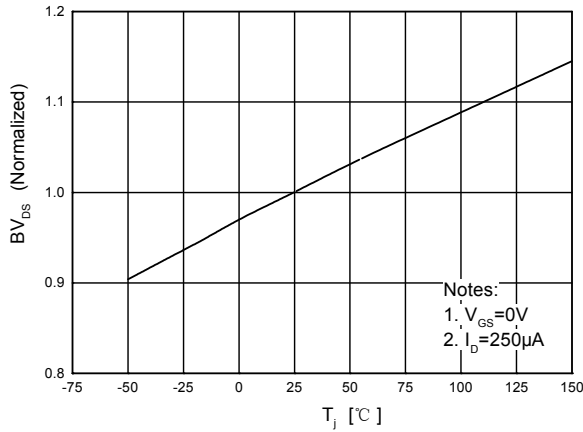
Gate Charge Characteristics



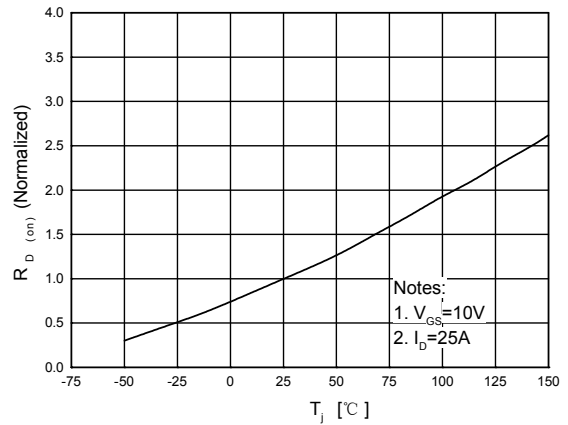


特征曲线 ELECTRICAL CHARACTERISTICS (curves)

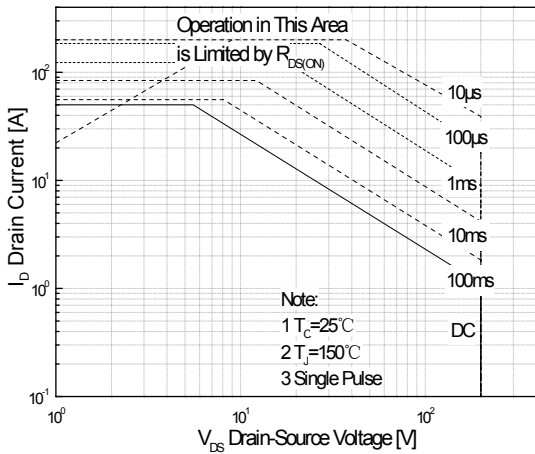
**Breakdown Voltage Variation vs. Temperature**



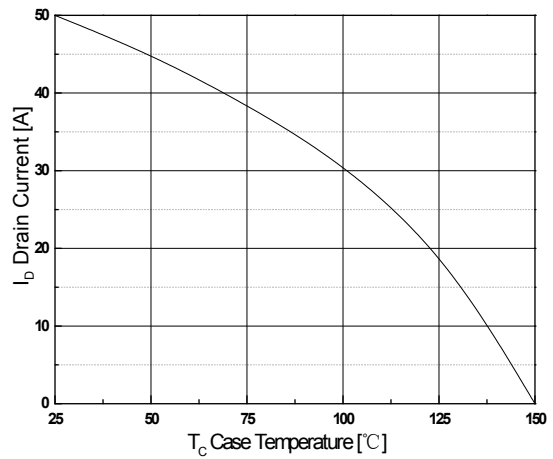
**On-Resistance Variation vs. Temperature**



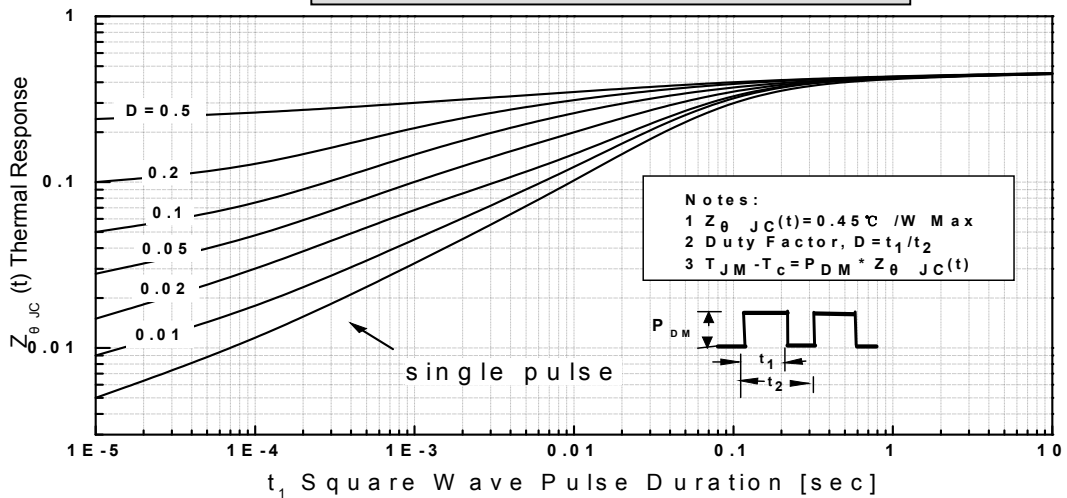
**Maximum Safe Operating Area**

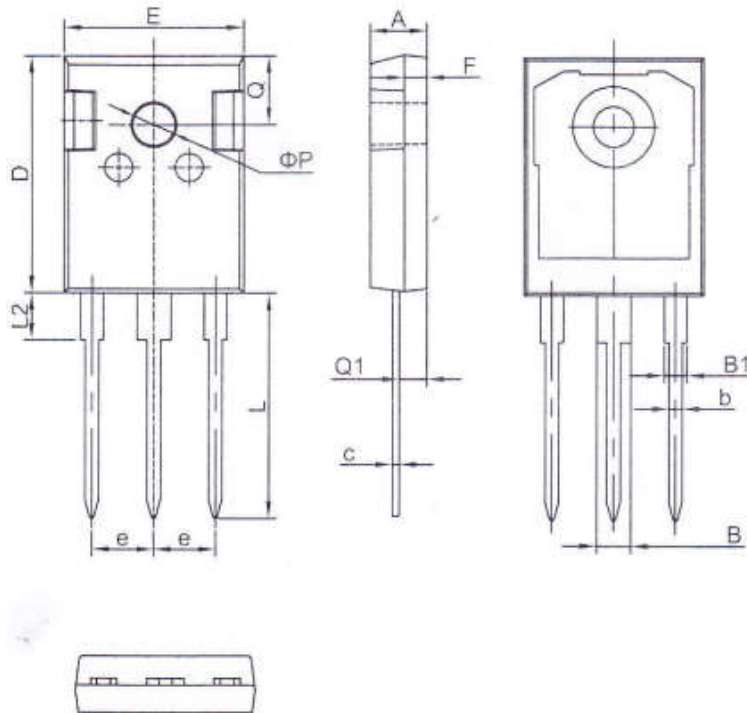


**Maximum Drain Current vs. Case Temperature**



**Transient Thermal Response Curve**





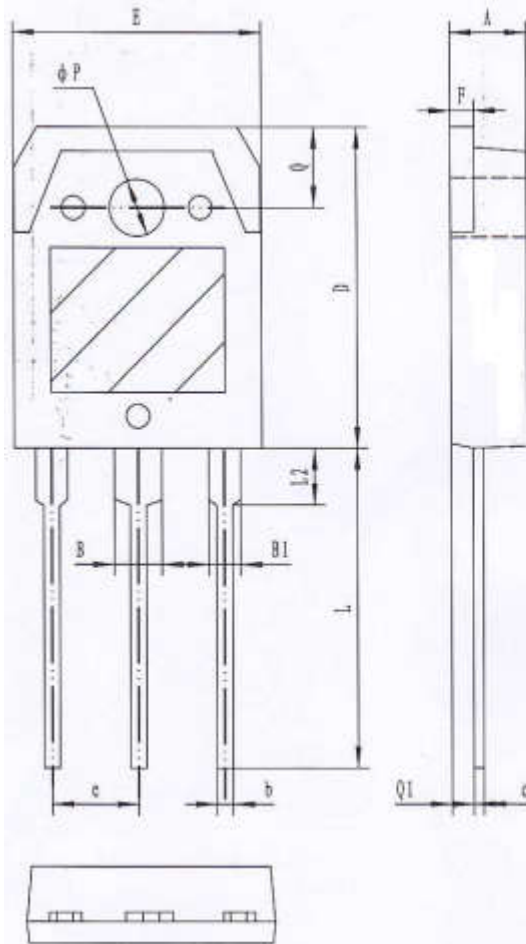
符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70





TO-3PB

单位 Unit: mm



符号 symbol	MIN	MAX
A	4.60	5.00
B	2.90	3.20
B1	1.90	2.20
b	0.90	1.10
c	0.50	0.70
D	19.40	20.40
E	15.40	15.80
e	5.45(TYP)	
F	1.40	1.60
L	19.50	20.50
L2	3.30	3.70
Q	4.90	5.10
Q1	1.30	1.50
P	3.10	3.50







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